



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.: 10/647,297 Group Art Unit: 1794

Filing Date: August 26, 2003 Examiner: Hai Vo

Applicants: Hyun HUH et al. Conf. No.: 2580

Title: POLISHING PAD CONTAINING EMBEDDED

LIQUID MICROELEMENTS AND METHOD OF

MANUFACTURING THE SAME

Attorney Docket: 47881-000003/US

Customer Service Window March 9, 2009

Randolph Building 401 Dulany Street Alexandria, VA 22314 Mail Stop AF

DO NOT ENTER: /H.V./

03/27/2009

AMENDMENT UNDER 37 C.F.R. § 1.116

Sir:

In response to the Office Action mailed January 9, 2009, the following remarks are respectfully submitted in connection with the above-identified application.

 $\label{lem:manuscondition} \textbf{Amendments to the Claims} \ \text{begins on page 2 of this Amendment}.$

Remarks begin on page 5 of this Amendment.

0.5	Claims remaining after Amendment		Highest number previously paid for		Present extra
Total	14	-	31	=	0
Independent	1	-	3	=	0